

### The next generation cameras for the Large-Sized Telescopes of the Cherenkov Telescope Array Observatory

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# Outline





Cosmic rays and extensive air showers.

The Large – Sized Telescopes (LSTs) for gamma ray detection.

### LST photo sensitive camera.

The current Photo-Multiplier Tube (PMT) - based camera.

The advanced camera: next generation of LST cameras based on silicon photo-multipliers SiPMs

Night sky background mitigation

Readout chain and light sensor

Data volume reduction with digital sum and DBSCAN.

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# **Cosmic rays and extensive air shower (EAS)**





The cascade of secondary particles initiated by a single primary particle will produce Cherenkov photons in the atmosphere, primarily generated by electrons, positrons, and muons. This light can be detected by Cherenkov telescopes.

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# The Large – Sized Telescop the Cherenkov Telescope for gamma ray detection





Parabolic mirror 198 hexagonal mirrors ~1.5 m flat to flat size **Dish diameter 23 m** Mirror area ~ 400 m<sup>2</sup> **Focal Length 28 m** Field of view ~ 4.4° Design on-axis PSF 0.05°

The CTAO\* LSTs are in an array of 4, will dominate the energy region of the sensitivity between 20 GeV and few 100 GeV.

\*CTAO : Cherenkov Telescope Array Observatory

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proton\_gamma.gif



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### Silicone Photo-multipliers camera for LST





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3

# The LST PMT camera to LST SiPM camera









# LST PMT camera (0.1°)

# LST SiPM camera (0.05°)



# Various options to filter night sky background Entrance window Light guides





-400

-200

0

X position (mm)

#### 45% 45% 40% after 35% osstalk and 30% 25% 5 **DE** (not include o 12%) 10% 20% 20% 0% 200 300 80% of the light undergoes reflections 14 12 probability (%) Having "blue" light guides improves 10 8

absorption > 540 nm ICRR, University of Tokyo, Kyoto University Konan University, ISEE, Nagoya University







Dichroic filter done directly on the bare silicon surface

Very uniform but increases optical cross talk



### Light sensors and readout electronics characterization







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Picoammeters for precise current measurements and SiPM bias.

Pulsed and continues light sources Motorized wheel with neutral density filters Temperature and humidity sensors Calibrated photodiodes 2 GHz readout oscilloscope

We plan to add 3D translational stage

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# The silicon photomultiplier (SiPM) light sensor.

- -> Collaboration between the University of Geneva and Hamamatsu for IACT\*.
- → Comparison with FbK.
- $\rightarrow$  All the measurements done by UNIGE team.



	HAMAMATSU LCT5	FBK NUV-HD	FBK NUV-HD MT**
PDE (photo det. Eff.), [%]	50 % at 300 nm 60 % at 400 nm	45 % at 300 nm 65 % at 400 nm	57 % at 450 nm
DCR[MHz/cm <sup>2</sup> ]	2.5 at 6V <sub>ov</sub>	25 at 6V <sub>ov</sub>	6 at 6V <sub>ov</sub>
OCT (Opt. x-talk) [%]	12 % at $6V_{ov}$	20 % at $6V_{ov}$	4 % at $6V_{ov}$
Pulse FWHM [ns]	3	8	~3 (with shaping ampl.)

\*Imaging Atmospheric Cherenkov Telescope.

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\*\*Very promising device but the packaging remains the major issue.

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### **FANATIC\* – the preamplifier ASIC**

-Fully developed by UNIGE, Swiss companies involved for chip packaging.

→ The chips wire bonded at UNIGE.

FLARE project (20FL21-201539)



### Main specification:

Power consumption: 40 mW per pixel Dynamic range: 1-250 p.e (good linearity) Signal-to-noise ratio of 5 Fast response: 3-5 ns FWHM

Second version of the ASIC designed in collaboration with Spain

Time line :

52.0

104.0

156.0

208.0

Design end of 2024 Production April 2025

260.0





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### \* Fast ANAlog Transimpedance amplifier Integrated Circuit

#### 15

### L1 board and Telescope Central Trigger **Processor (CTP) board**

### Main components are :

FADC (commercial or custom designed by EPFL)

FPGA: AMD / Xilinx Kintex UltraScale+ **Functionalities:** 

Capture and buffer FADC stream Perform low level trigger (digital sum of super flower) Send to Central Trigger Processor only "triggered events" Reads 49 pixel (super flower or flower of flowers)

Each L1 board connected to neighbor with 1 or 2 10Gbps links.



PCB development:

Front – end board

Design finished and files sent to the manufacturing company.

Right now, they are inspecting the design.







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FLARE project (20FL21-201539)

### **CTP** board

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Front – end board

# Level 1 trigger based on digital sum





It serves as an effective signal amplifier and noise cancellation.

Example of the waveform with 0, 1, 2, 3 photon



### **Different topologies**



### Level 2 trigger based on DBSCAN **Density Based Spatial Clustering of Applications with Noise**



**Telescope FPGA** 

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L1 FPGA

L1 FPGA

1400 point ID

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0

200

400

600

800

1000

1200



### **DBSCAN vs. super flower digital sum**





### **Trigger effective area (on axis gammas)**

#### UNIVERSITÉ **Hardware implementation** CTA DF GFNÈVE (preliminary feasibility study for FPGA) FACULTÉ DES SCIENCES **Off line operation (Level 2 trigger)** DBSCAN would run on stereo triggered events, with latency of about $\sim 3 \mu s$ . Accelerating the DBSCAN clustering algorithm for low-latency primary vertex reconstruction https://indico.cern.ch/event/1106990/contributions/4998133/ Alex Tapper (Imperial College London) Latency Andrew Rose With 230 tracks (points) they got **0.726 µs** latency. FPGA = 0.726 us Lucas Santiago Borgna (Imperial College (GB)) $CPU = 92.7 \ \mu s$ Marco Barbone VU9P FPGA 127× L Robert John Bainbridge (Imperial College (GB)) Speedup! Wayne Luk <sup>¬</sup>.2000 0g -3640. 1800 [<u>j</u> Real time (Level 1 trigger) ? 8.505 p1 p2 0.04395 1600 DBSCAN would run in real time at $\sim$ 10 MHz. 1400 latency of 0.01 $\mu$ s is required in this case. 1200 We have ~ 3 times less points (micro 1000 clusters), corresponds to 0.07 µs latency. 800

Possible algorithm optimization - time axis is fully ordered.



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# Thank you very much for your attention

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